IP P.	HEWLETT-PACKARD COMPANY Intellectual Property Administration P. D. Box 272400		l	0-06-024	PATENT APPLICATION $AF$ attorney docket no10011880-1 $EFU$						
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In	ventov (s):	Buswell et al.			C	onfirmation	No.: 20	65			
ARE	Application No.: 10/061,492				Examiner: Culbert, R.						
	ling Date:	01-31-2002	Group Art Unit: 1763								
Tit	tle:	Methods and System Microelectronics	ems for F	or Forming Slots in a Semiconductor Substrate Containing							
Co PC	ail Stop AF ommissioner f O Box 1450 lexandria, VA	22313-1450									
Si		TRANSMITTAL LETTER FOR RESPONSE/AMENDMENT									
() ( ()	() Response	e/Amendment as calculated below ional fee	-	in the above-identified application: () Petition to extend time to respond () Supplemental Declaration (fee \$)							
		CLAIMS AS AMENDED BY OTHER THAN A SMALL ENTITY									
	(1) FOR	(2) CLAIMS REMAINING AFTER AMENDMENT	(3) NUMBER EXTRA	(4) HIGHEST NUMBER PREVIOUSLY PAID FOR	(5) PRESENT EXTRA	(6) RATE	ADDI	7) FIONAL ÆS			
	TOTAL CLAIMS		MINUS		= 0	× \$18	\$	0			
	INDEP. CLAIMS		MINUS		= 0	× \$86	\$	0			
	[ ] FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM + \$290						\$	0			
	EXTENSION FEE	N 1ST MONTH \$110.00					\$	0			
				OTHER FEES \$							
	TOTAL ADDITIONAL FEE FOR THIS AMENDMENT						\$	0			
C	harge \$	n to Der	osit Acc	ount 08-2025. At	anv time di	uring the p	endency	of this			

application, please charge any fees required or credit any overpayment to Deposit Account 08-2025 pursuant to 37 CFR 1.25. Additionally please charge any fees to Deposit Account 08-2025 under 37 CFR 1.16 through 1.21 inclusive, and any other sections in Title 37 of the Code of Federal Regulations that may regulate fees. A duplicate copy of this sheet is enclosed.

"Express Mail" label no. EV 486243113 US

Date of Deposit 10-05-2004

I hereby certify that this is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to: Commissioner 22313-7450. for Patents, Alexandria, VA

By Typed Máme: Cartin Taylor

Respectfully submitted,

Buswell et/al By

Paul W. Mitchell

Attorney/Agent for Applicant(s) Reg. No. 44,453

Date: 10-05-2004

Rev 05/04 (TnAmdExp)

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Telephone No.: (509) 324-9256

- Attach as First Page to Transmitted Papers -



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventors:	Buswell et al.	Examiner:	Culbert, R.
Serial No:	10/061,492	Group Art Unit:	1763
Filing Date:	1/31/02	<b>Confirmation No:</b>	2065

**Title:** Methods and Systems for Forming Slots in a Semiconductor Substrate Containing Microelectronics

To: Commissioner of Patents and Trademarks PO Box 1450 Alexandria, VA 22313-1450

From: Hewlett-Packard Development Company, L.P Intellectual Property Administration P.O. Box 272400 Fort Collins, Colorado 80527-2400

## **RESPONSE AFTER FINAL REJECTION**

## **INTRODUCTORY COMMENTS**

This communication is in response to the Final Office Action dated 8/05/04, for which a three-month shortened statutory period for response is set for 11/05/04. Applicant submits this communication within a two month time period and respectfully requests that this communication be entered and that a responsive advisory action be generated. Please amend the above-identified application as set forth below.

Amendment to the Claims are reflected on the list of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.